



NEC's BROADBAND GaAs MMIC DPDT SWITCH | UPG2035T5F FOR 2.4 GHz AND 5 GHz WLAN

FEATURES

- **OPERATING FREQUENCY:**
2.4 to 2.5 GHz and 4.9 to 6.0 GHz (specified)
2.0 to 6.0 GHz Broadband Operation (unspecified)
- **LOW INSERTION LOSS:**
0.8 dB TYP. @ 2.4 to 2.5 GHz
1.2 dB TYP. @ 4.9 to 6.0 GHz
- **POWER HANDLING:**
 $P_{in (1\text{ dB})} = +31\text{ dBm TYP. @ 2.4 to 2.5 GHz}$
 $+30\text{ dBm TYP. @ 4.9 to 6.0 GHz}$
- **CONTROL VOLTAGE:**
+3.0 V / 0 V (Dual control)
- **HIGH ISOLATION:**
INPUT to OUTPUT = 34 dB TYP. @ 2.4 to 2.5 GHz
INPUT to OUTPUT = 33 dB TYP. @ 4.9 to 6.0 GHz
TX to RX, ANT1 to ANT2 = 24 dB TYP. @ 2.4 to 2.5 GHz
TX to RX, ANT1 to ANT2 = 22 dB TYP. @ 4.9 to 6.0 GHz
- **INPUT/OUTPUT RETURN LOSS:**
15 dB TYP.
- **SWITCHING SPEED:**
50 ns @ t_{RISE}/t_{FALL} (10/90% RF)
- **12-PIN PLASTIC QFN PACKAGE:**
(3.0 × 3.0 × 0.75 mm)
- **Pb FREE**

DESCRIPTION

NEC's UPG2035T5F is a GaAs MMIC DPDT switch for 2.4 GHz and 5 GHz dualband Wireless LAN.

The UPG2035T5F features low insertion loss, high isolation, and dualband operation.

APPLICATIONS

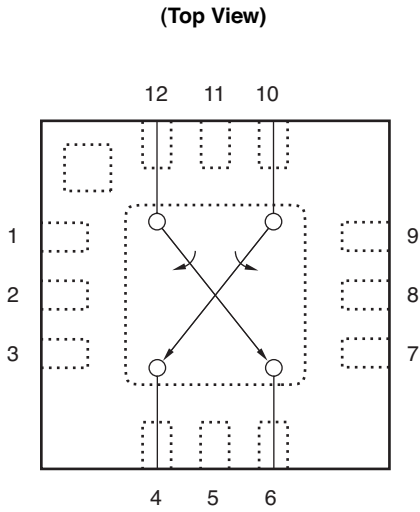
- **802.11a+b/g WIRELESS LAN**
- **2.0 TO 6.0 GHz T/R SWITCHING**
- **2.0 TO 6.0 GHz ANTENNA DIVERSITY SWITCHING**

ORDERING INFORMATION

PART NUMBER	ORDER NUMBER	PACKAGE	MARKING	SUPPLYING FORM
UPG2035T5F-E2	UPG2035T5F-E2-A	12-pin plastic QFN (Pb-Free)	2035	<ul style="list-style-type: none"> • Embossed tape 8 mm wide • Pin 1 indicates roll-in direction of tape • Qty 3 kpcs/reel

Remark To order evaluation samples, contact your nearby sales office.
Part number for sample order: UPG2035T5F-A

PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



PIN NO.	PIN NAME	DESCRIPTION
1	NC	Ground
2	NC	Ground
3	V _{cont1}	Control 1
4	ANT1	Antenna Port 1
5	NC	Ground
6	ANT2	Antenna Port 2
7	V _{cont2}	Control 2
8	NC	Ground
9	NC	Ground
10	RX	Receive Port
11	NC	Ground
12	TX	Transmit Port
EXPOSED PAD	GND	Ground

Remark NC indicates functionally non-connected pins, but actual grounding is recommended.

TRUTH TABLE

V _{cont1}	V _{cont2}	ANT1-RX	ANT1-TX	ANT2-TX	ANT2-RX
2.7 to 5.0 V	0 ± 0.2 V	ON	OFF	ON	OFF
0 ± 0.2 V	2.7 to 5.0 V	OFF	ON	OFF	ON

ABSOLUTE MAXIMUM RATINGS (T_A = +25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Switch Control Voltage	V _{cont}	-6.0 to +6.0 ^{Note 1}	V
Input Power	P _{in}	+36	dBm
Total Power Dissipation	P _{tot}	0.15 ^{Note 2}	W
Operating Ambient Temperature	T _A	-45 to +85	°C
Storage Temperature	T _{stg}	-55 to +150	°C

- Notes**
1. $|V_{cont1} - V_{cont2}| \leq 6.0 \text{ V}$
 2. Mounted on double-sided copper-clad 50 × 50 × 1.6 mm epoxy glass PWB, T_A = +85°C

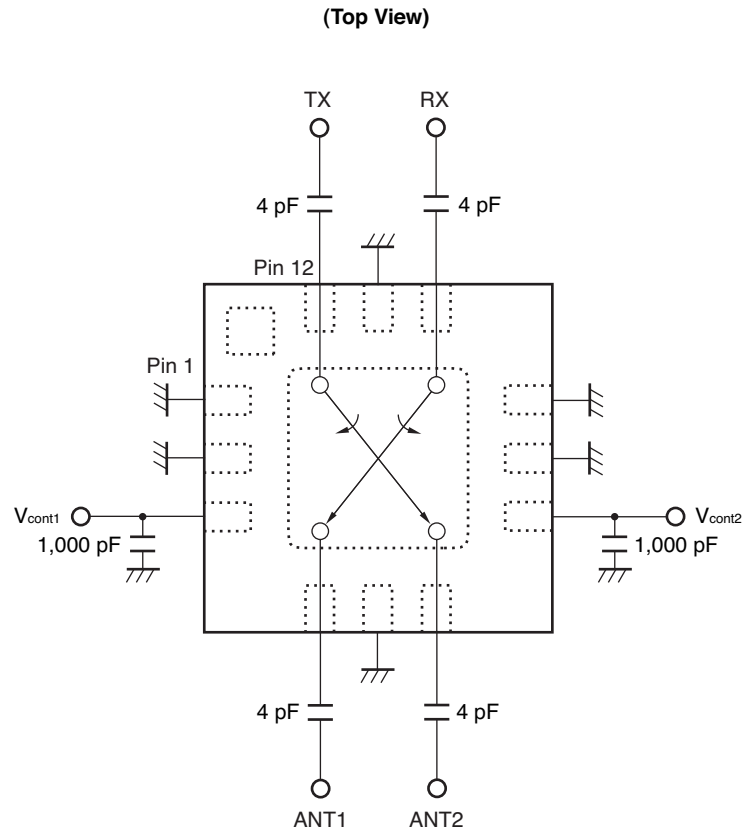
RECOMMENDED OPERATING RANGE ($T_A = +25^\circ\text{C}$)

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Operating Frequency 1	f1	2.4	–	2.5	GHz
Operating Frequency 2	f2	4.9	–	6.0	GHz
Switch Control Voltage (H)	V _{cont (H)}	2.7	3.0	5.0	V
Switch Control Voltage (L)	V _{cont (L)}	–0.2	0	0.2	V

ELECTRICAL CHARACTERISTICS ($T_A = +25^\circ\text{C}$, V_{cont} = 3.0 V/0 V, Z_O = 50 Ω, DC blocking capacitors value: 4 pF, Each port, unless otherwise specified)

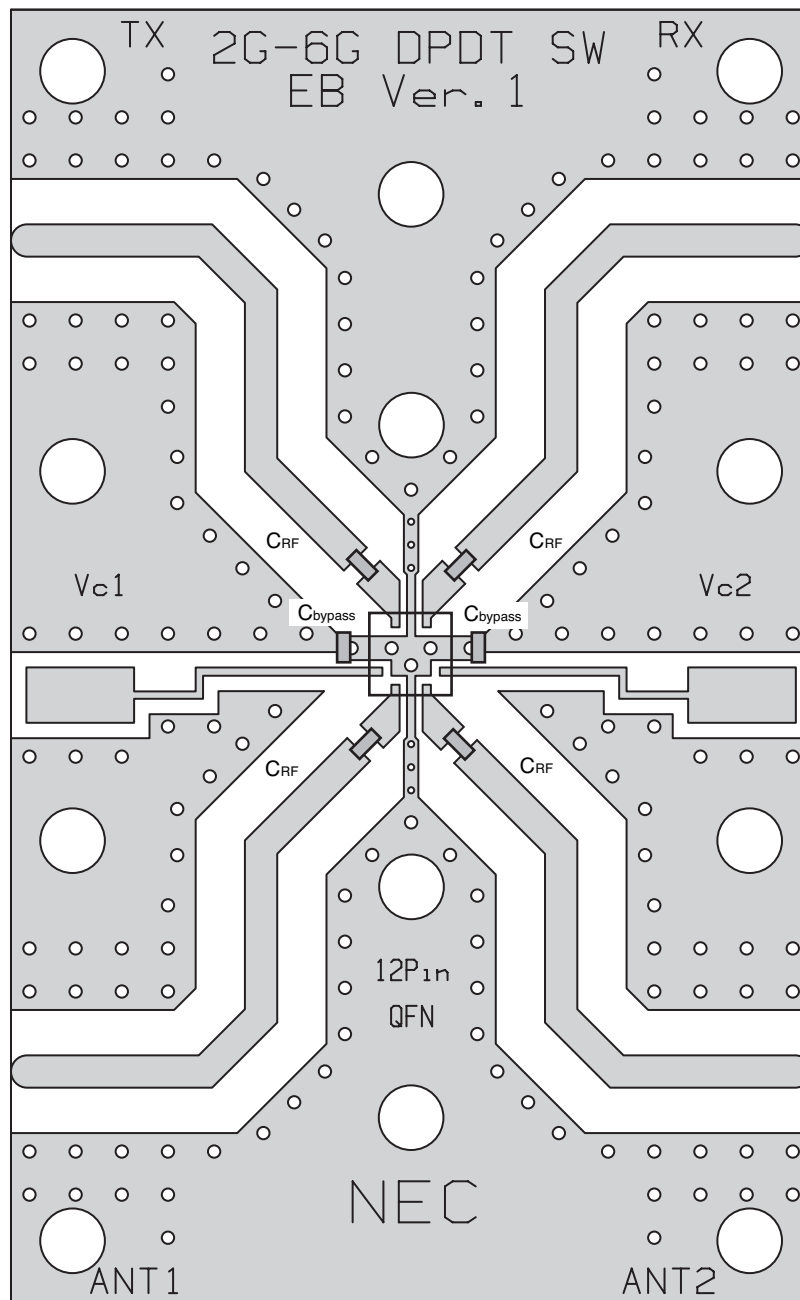
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Insertion Loss 1	L _{INS1}	f = 2.4 to 2.5 GHz	–	0.8	1.0	dB
Insertion Loss 2	L _{INS2}	f = 4.9 to 6.0 GHz	–	1.2	1.4	dB
Isolation 1 (INPUT to OUTPUT)	ISL1	f = 2.4 to 2.5 GHz	25	34	–	dB
Isolation 2 (INPUT to OUTPUT)	ISL2	f = 4.9 to 6.0 GHz	25	33	–	dB
Isolation 3 (TX to RX, ANT1 to ANT2)	ISL3	f = 2.4 to 2.5 GHz	17	24	–	dB
Isolation 4 (TX to RX, ANT1 to ANT2)	ISL4	f = 4.9 to 6.0 GHz	17	22	–	dB
Input and Output Return Loss 1	RL1	f = 2.4 to 2.5 GHz	–	15	–	dB
Input and Output Return Loss 2	RL2	f = 4.9 to 6.0 GHz	–	15	–	dB
Switch Control Current 1	I _{cont 1}	f = 2.4 to 2.5 GHz	–	0.7	1.5	μA
Switch Control Current 2	I _{cont 2}	f = 4.9 to 6.0 GHz	–	0.7	1.5	μA
1 dB Gain Compression Input Power	P _{in (1 dB)}	f = 2.4 to 2.5 GHz	–	31	–	dBm
		f = 4.9 to 6.0 GHz	–	30	–	
3rd Order Distortion Input Intercept Point 1	IIP _{3 1}	f = 2.4 to 2.5 GHz	–	45	–	dBm
3rd Order Distortion Input Intercept Point 2	IIP _{3 2}	f = 4.9 to 6.0 GHz	–	45	–	dBm
Switch Control Speed 1	t _{sw 1}	f = 2.4 to 2.5 GHz, t _{RISE} /t _{FALL} (10/90% RF)	–	50	–	ns
Switch Control Speed 2	t _{sw 2}	f = 4.9 to 6.0 GHz, t _{RISE} /t _{FALL} (10/90% RF)	–	50	–	ns

EVALUATION CIRCUIT



This application circuit and its parameters are for reference only.

ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD

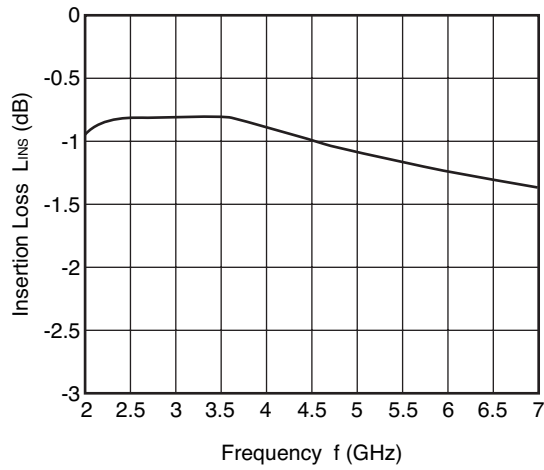


USING THE NEC EVALUATION BOARD

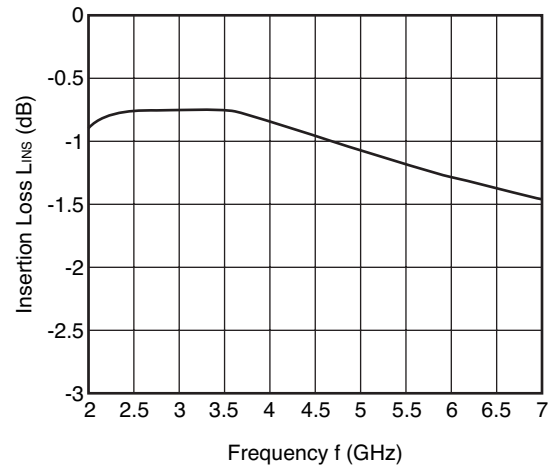
SYMBOL	FORM	RATING	PART NUMBER	MANUFACTURER
C _{RF}	Chip Capacitor	4 pF	GRM1552C1H4R0CZ01B	muRata
C _{bypass}	Chip Capacitor	1 000 pF	GRM155B11H102KA01B	muRata
-	PC Terminal	-	A2-2PA-2.54DSA	Hirose
-	RF Connector	-	142-0721-821	Johnson
-	PWB	-	RO4003 (t = 0.51 mm)	Rogers

TYPICAL CHARACTERISTICS ($T_A = +25^\circ\text{C}$, $V_{\text{cont}} = 3.0\text{ V/0 V}$, $Z_0 = 50\ \Omega$, DC block capacitor = 4 pF using test fixture, unless otherwise specified)

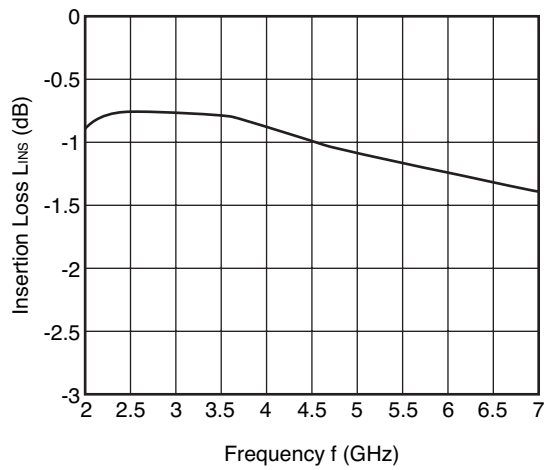
TX-ANT1 INSERTION LOSS vs. FREQUENCY
(When TX-ANT1 and ANT2-RX are ON)



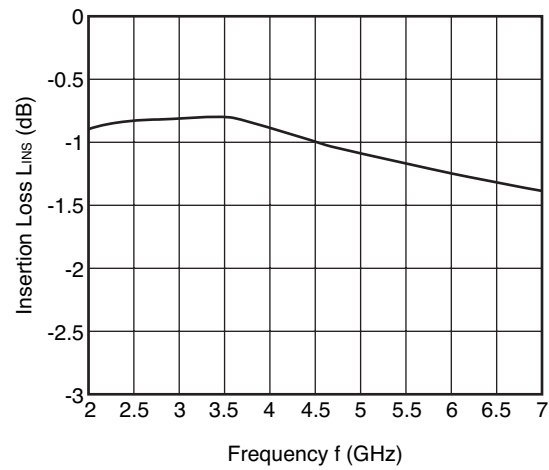
ANT1-RX INSERTION LOSS vs. FREQUENCY
(When TX-ANT2 and ANT1-RX are ON)



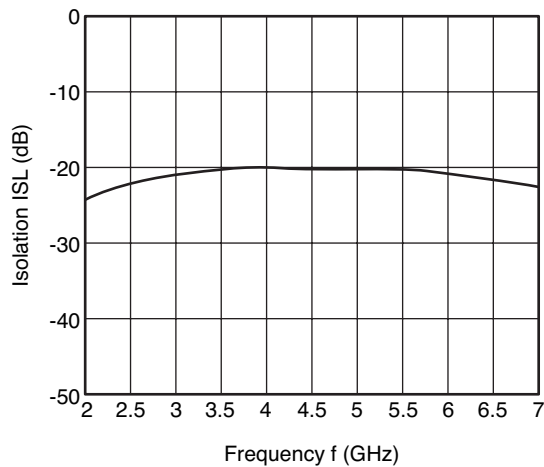
TX-ANT2 INSERTION LOSS vs. FREQUENCY
(When TX-ANT2 and ANT1-RX are ON)



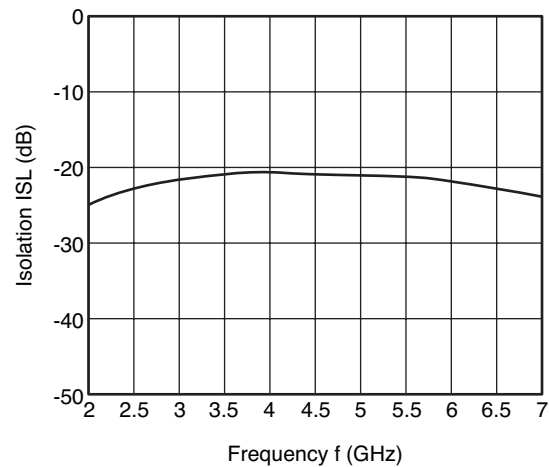
ANT2-RX INSERTION LOSS vs. FREQUENCY
(When TX-ANT1 and ANT2-RX are ON)



TX-RX ISOLATION vs. FREQUENCY
(When TX-ANT2 and ANT1-RX are ON)

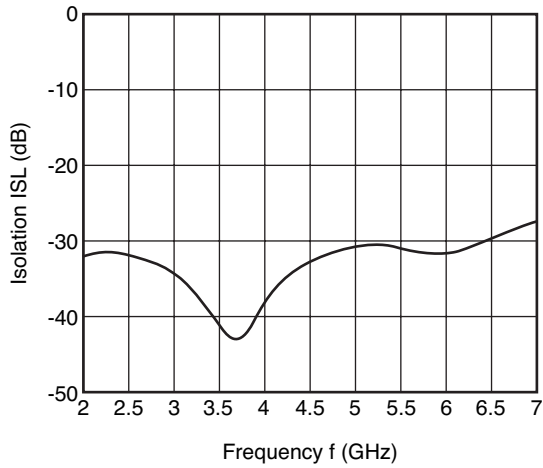


TX-RX ISOLATION vs. FREQUENCY
(When TX-ANT1 and ANT2-RX are ON)

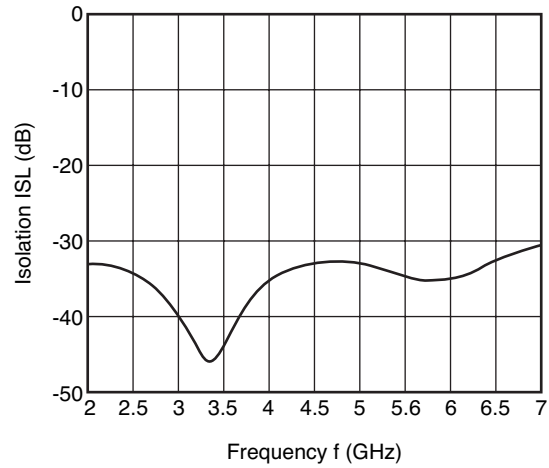


Remark The graphs indicate nominal characteristics.

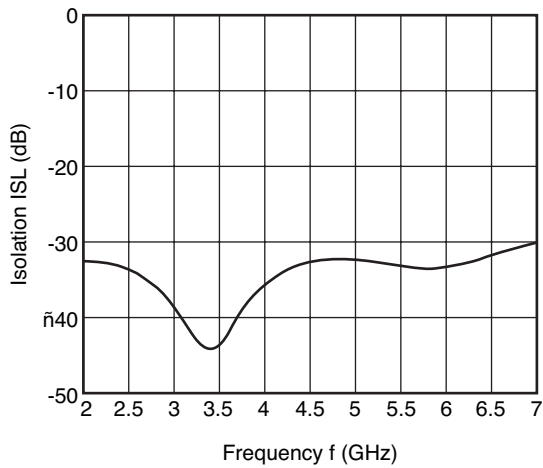
TX-ANT1 ISOLATION vs. FREQUENCY
(When TX-ANT2 and ANT1-RX are ON)



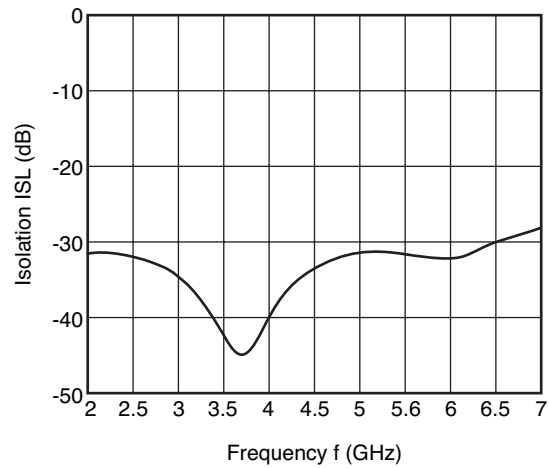
ANT1-RX ISOLATION vs. FREQUENCY
(When TX-ANT1 and ANT2-RX are ON)



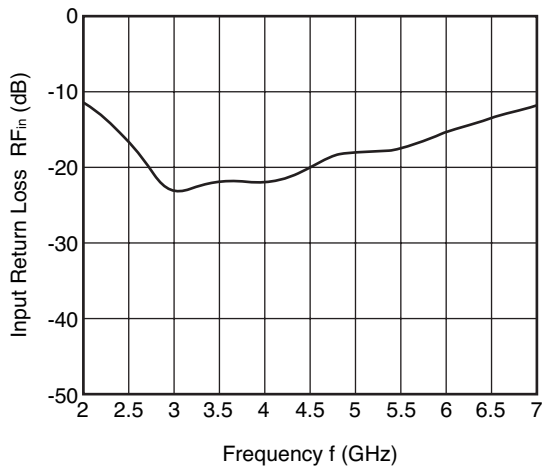
TX-ANT2 ISOLATION vs. FREQUENCY
(When TX-ANT1 and ANT2-RX are ON)



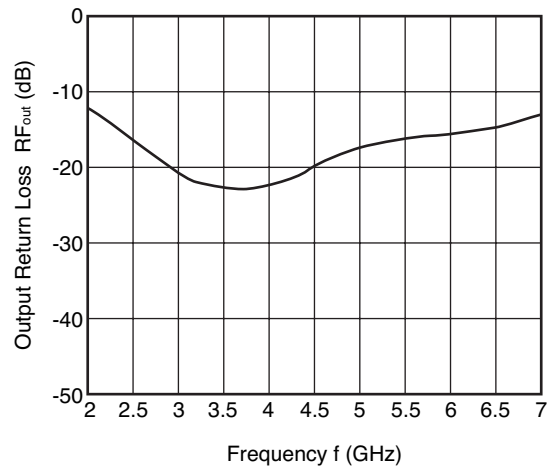
ANT2-RX ISOLATION vs. FREQUENCY
(When TX-ANT2 and ANT1-RX are ON)



TX-ANT1 INPUT RETURN LOSS vs. FREQUENCY
(When TX-ANT1 and ANT2-RX are ON)

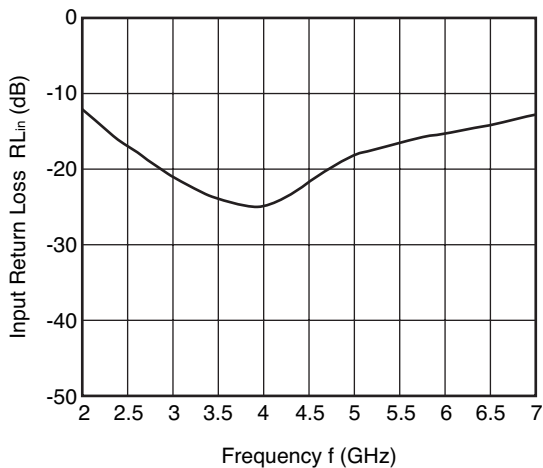


ANT1-RX OUTPUT RETURN LOSS vs. FREQUENCY
(When TX-ANT2 and ANT1-RX are ON)

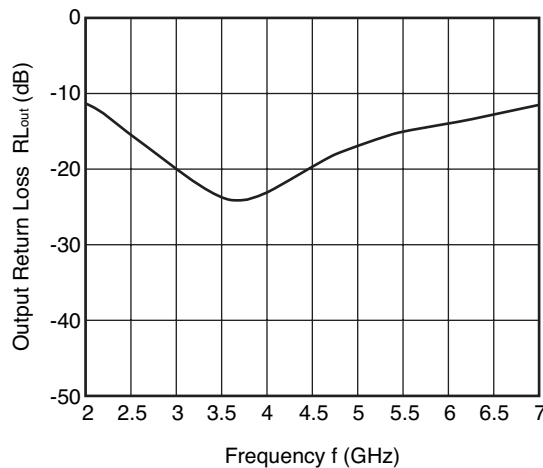


Remark The graphs indicate nominal characteristics.

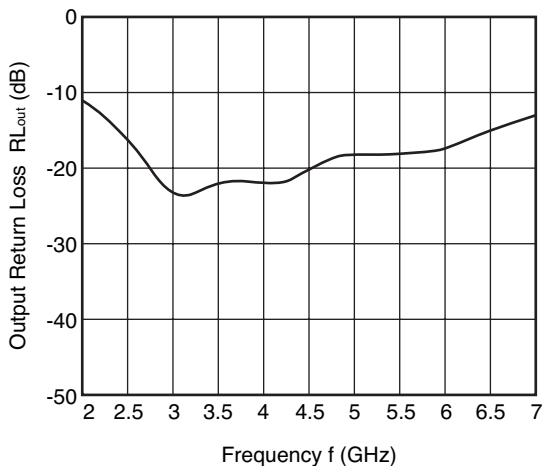
TX-ANT2 INPUT RETURN LOSS vs. FREQUENCY
(When TX-ANT2 and ANT1-RX are ON)



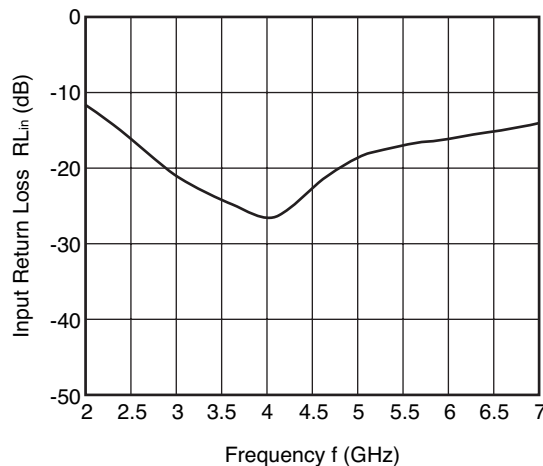
ANT2-RX OUTPUT RETURN LOSS vs. FREQUENCY
(When TX-ANT1 and ANT2-RX are ON)



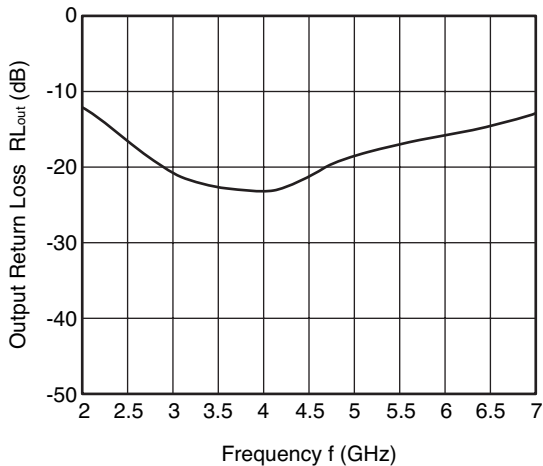
TX-ANT1 OUTPUT RETURN LOSS vs. FREQUENCY
(When TX-ANT1 and ANT2-RX are ON)



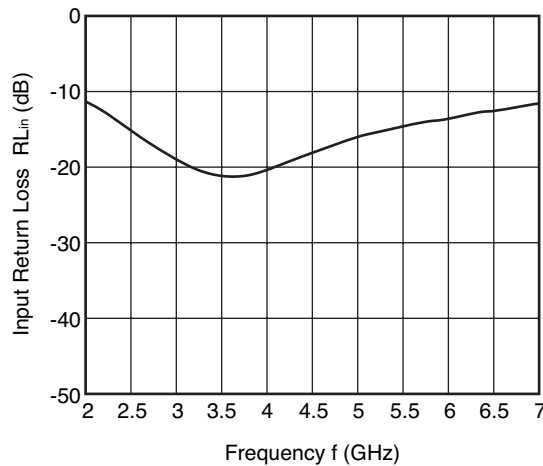
ANT1-RX INPUT RETURN LOSS vs. FREQUENCY
(When TX-ANT2 and ANT1-RX are ON)



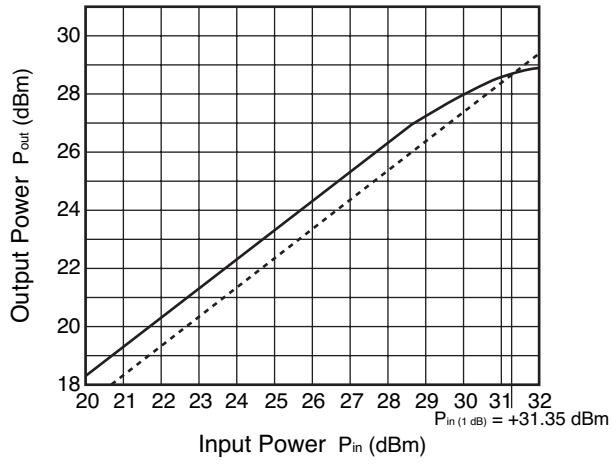
TX-ANT2 OUTPUT RETURN LOSS vs. FREQUENCY
(When TX-ANT2 and ANT1-RX are ON)



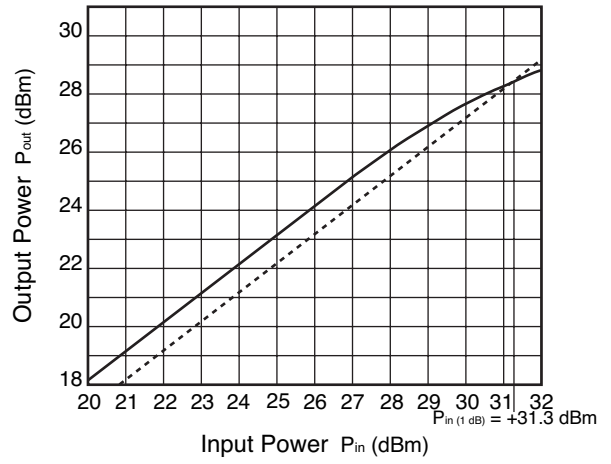
ANT2-RX INPUT RETURN LOSS vs. FREQUENCY
(When TX-ANT1 and ANT2-RX are ON)



OUTPUT POWER vs. INPUT POWER
(f = 2.4 GHz)

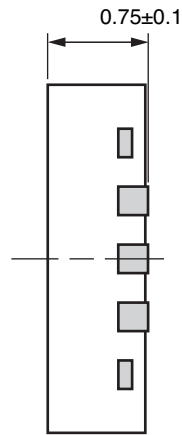
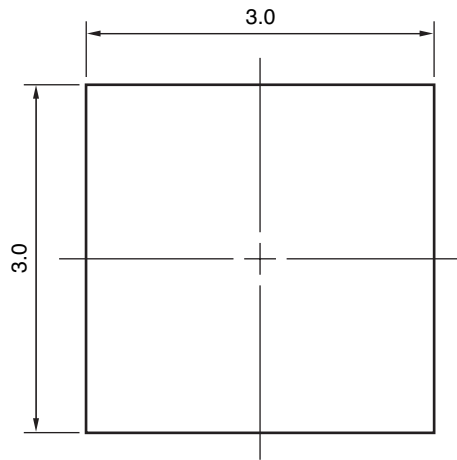


OUTPUT POWER vs. INPUT POWER
(f = 5.8 GHz)

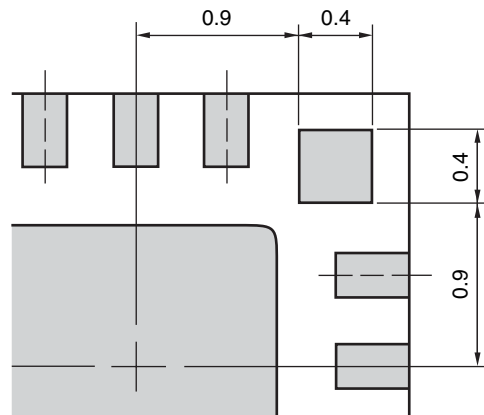
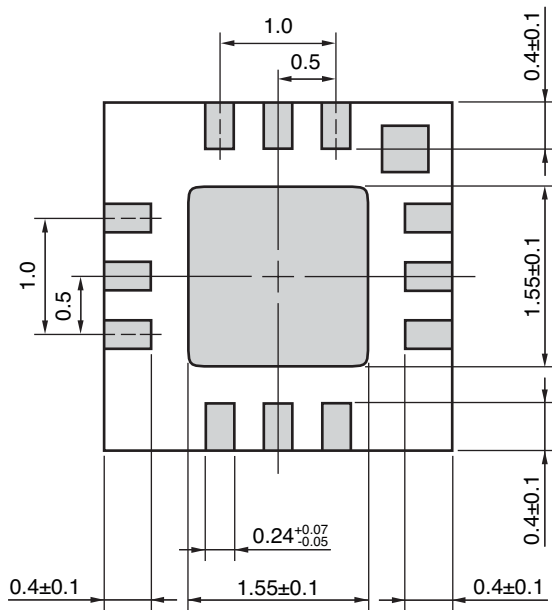


PACKAGE DIMENSIONS

12-PIN QFN (UNIT:mm)



(Bottom View)



Dimensions of pin No.1 indication

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) : 260°C or below Time at peak temperature : 10 seconds or less Time at temperature of 220°C or higher : 60 seconds or less Preheating time at 120 to 180°C : 120±30 seconds Maximum number of reflow processes : 3 times Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) : 260°C or below Time at peak temperature : 10 seconds or less Preheating temperature (package surface temperature) : 120°C or below Maximum number of flow processes : 1 time Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (pin temperature) : 350°C or below Soldering time (per side of device) : 3 seconds or less Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

Life Support Applications

These NEC products are not intended for use in life support devices, appliances, or systems where the malfunction of these products can reasonably be expected to result in personal injury. The customers of CEL using or selling these products for use in such applications do so at their own risk and agree to fully indemnify CEL for all damages resulting from such improper use or sale.

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